# 1532273-1 ✓ ACTIVE

#### Microdot

TE Internal #: 1532273-1

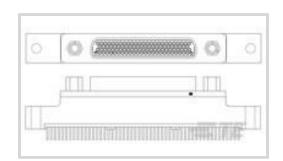
Plug, Wire-to-Board, 100 Position, 1.27 mm [.05 in] Centerline, Printed Circuit Board, Signal, Microminiature & Nanominiature D

Connectors

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Connectors > D-Shaped Connectors > Microminiature & Nanominiature D Connectors



Connector & Housing Type: Plug
Connector System: Wire-to-Board

Number of Positions: 100

Centerline (Pitch): 1.27 mm [ .05 in ]

Connector & Contact Terminates To: Printed Circuit Board

#### **Features**

## **Product Type Features**

Connector & Housing Type	Plug
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	100
Body Features	
Shell Plating Material	Cadmium
Flying Leads Length	2.77 mm[.109 in]
Contact Features	

Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Base Material	Beryllium Copper
Contact Options	Installed
Contact Current Rating (Max)	3 A

# **Termination Features**

Termination Method to PCB	Through Hole - Solder
Termination Method to Wire & Cable	Preterminated Flying Leads

#### Mechanical Attachment



Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Signal

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241)  Candidate List Declared Against: JAN 2024 (240)  SVHC > Threshold:  Cd (.2% in Component part)  Article Safe Usage Statements:  Use personal protective equipment as required. Do not eat, drink or smoke when using this product. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Not lead free process capable

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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